

APT2X101S20J 200V 120A

DUAL DIE ISOTOP® PACKAGE

HIGH VOLTAGE SCHOTTKY DIODE

PRODUCT APPLICATIONS

- Rectifiers in Switchmode Power Supplies (SMPS)
- Free Wheeling Diode in Low Voltage Converters

PRODUCT FEATURES

- Ultrafast Recovery Times
- Soft Recovery Characteristics
- Popular SOT-227 Package
- Rugged - Avalanche Energy Rated
- Low Forward Voltage
- High Blocking Voltage
- Low Leakage Current

PRODUCT BENEFITS

- Low Losses
- Low Noise Switching
- Cooler Operation
- Higher Reliability Systems
- Increased System Power Density

MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT2X101S20J	UNIT
V_R	Maximum D.C. Reverse Voltage	200	Volts
V_{RRM}	Maximum Peak Repetitive Reverse Voltage		
V_{RWM}	Maximum Working Peak Reverse Voltage		
$I_{F(AV)}$	Maximum Average Forward Current ($T_C = 105^\circ\text{C}$, Duty Cycle = 0.5)	120	Amps
$I_{F(RMS)}$	RMS Forward Current (Square wave, 50% duty)	213	
I_{FSM}	Non-Repetitive Forward Surge Current ($T_J = 45^\circ\text{C}$, 8.3ms)	1000	
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ\text{C}$
E_{AVL}	Avalanche Energy (2A, 50mH)	100	mJ

STATIC ELECTRICAL CHARACTERISTICS

Symbol		MIN	TYP	MAX	UNIT
V_F	Forward Voltage	$I_F = 100\text{A}$		.89	Volts
		$I_F = 200\text{A}$		1.06	
		$I_F = 100\text{A}, T_J = 125^\circ\text{C}$		.76	
I_{RM}	Maximum Reverse Leakage Current	$V_R = 200\text{V}$		2	mA
		$V_R = 200\text{V}, T_J = 125^\circ\text{C}$		40	
C_T	Junction Capacitance, $V_R = 200\text{V}$		470		pF

DYNAMIC CHARACTERISTICS

APT2X101S20J

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t_{rr}	Reverse Recovery Time	$I_F = 100A$, $di_F/dt = -200A/\mu s$ $V_R = 133V$, $T_C = 25^\circ C$	-	70		ns
Q_{rr}	Reverse Recovery Charge		-	240		nC
I_{RRM}	Maximum Reverse Recovery Current		-	6	-	Amps
t_{rr}	Reverse Recovery Time	$I_F = 100A$, $di_F/dt = -200A/\mu s$ $V_R = 133V$, $T_C = 125^\circ C$	-	110		ns
Q_{rr}	Reverse Recovery Charge		-	690		nC
I_{RRM}	Maximum Reverse Recovery Current		-	11	-	Amps
t_{rr}	Reverse Recovery Time	$I_F = 100A$, $di_F/dt = -700A/\mu s$ $V_R = 133V$, $T_C = 125^\circ C$	-	95		ns
Q_{rr}	Reverse Recovery Charge		-	1750		nC
I_{RRM}	Maximum Reverse Recovery Current		-	32		Amps

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction-to-Case Thermal Resistance			.33	$^\circ C/W$
$V_{Isolation}$	RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500			Volts
W_T	Package Weight		1.03		oz
			29.2		g
Torque	Maximum Terminal & Mounting Torque			10	lb•in
				1.1	N•m

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

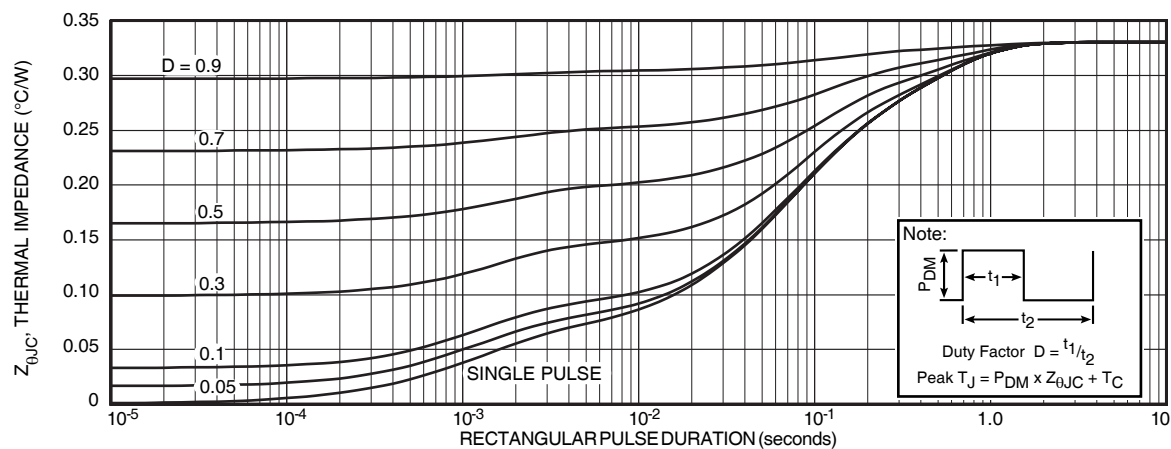


FIGURE 1a. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION

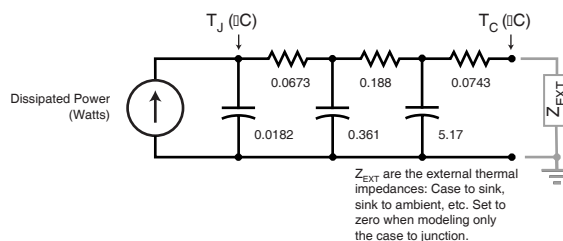


FIGURE 1b. TRANSIENT THERMAL IMPEDANCE MODEL

TYPICAL PERFORMANCE CURVES

APT2X101S20J

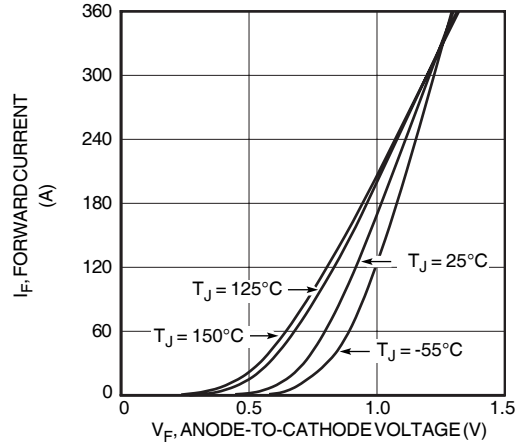


Figure 2. Forward Current vs. Forward Voltage

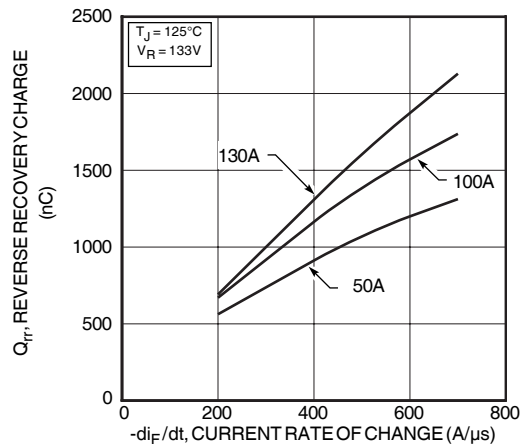


Figure 4. Reverse Recovery Charge vs. Current Rate of Change

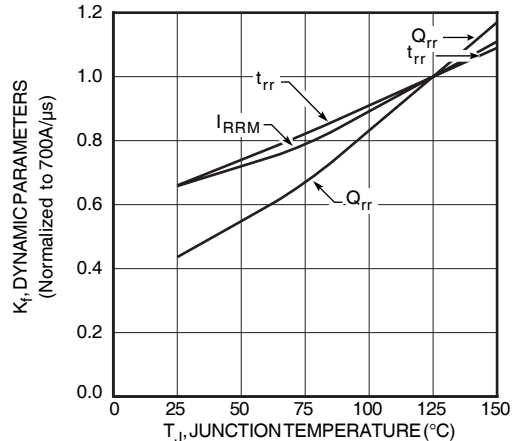


Figure 6. Dynamic Parameters vs. Junction Temperature

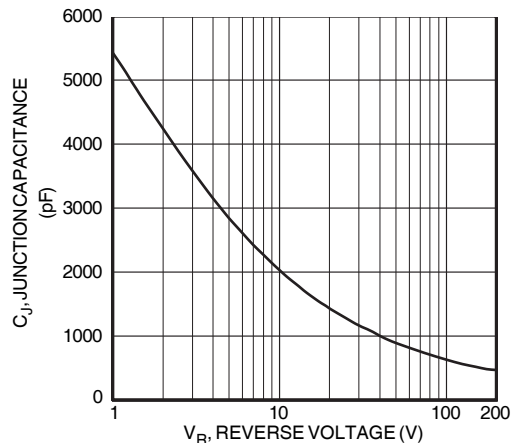


Figure 8. Junction Capacitance vs. Reverse Voltage

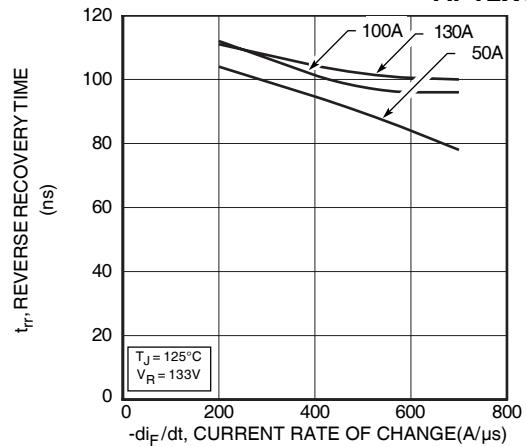


Figure 3. Reverse Recovery Time vs. Current Rate of Change

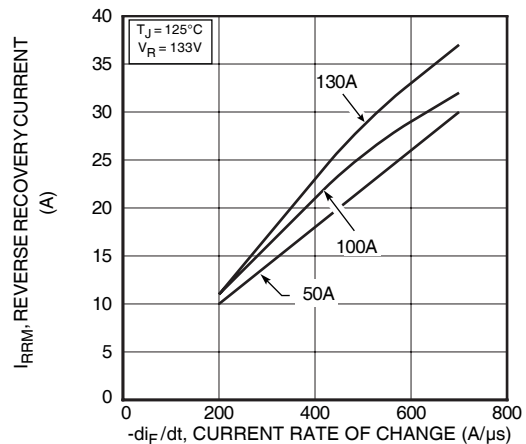


Figure 5. Reverse Recovery Current vs. Current Rate of Change

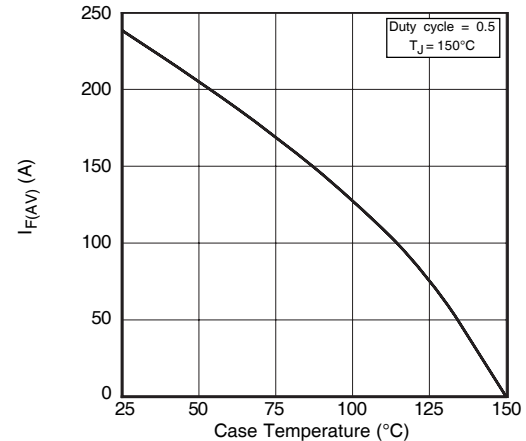


Figure 7. Maximum Average Forward Current vs. Case Temperature

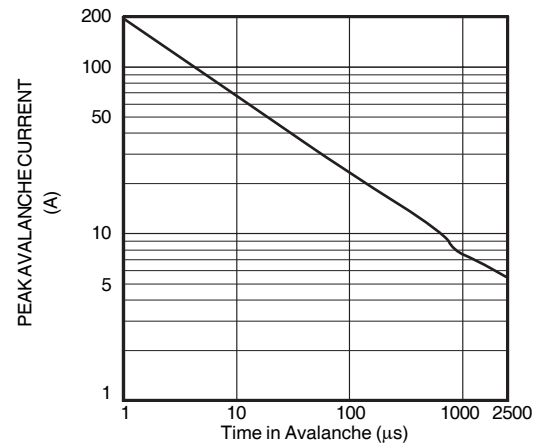


Figure 9. Single Pulse UIS SOA



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Figure 10, Diode Reverse Recovery Waveform and Definitions

Technical drawing of the APT2X101S20J component, showing dimensions in millimeters and inches.

Top View Dimensions:

- Overall width: 31.5 (1.240) / 31.7 (1.248)
- Overall height: 38.0 (1.496) / 38.2 (1.504)
- Distance between mounting holes: 14.9 (.587) / 15.1 (.594)
- Distance between internal features: 30.1 (1.185) / 30.3 (1.193)
- Radius: $r = 4.0 (.157)$ (2 places)
- Internal dimensions: 7.8 (.307) / 8.2 (.322)
- Internal dimensions: 4.0 (.157) / 4.2 (.165) (2 places)
- Internal dimensions: 3.3 (.129) / 3.6 (.143)
- Internal dimensions: 4.1 (.161) / 4.3 (.169) / 4.8 (.187) / 4.9 (.193) (4 places)

Side View Dimensions:

- Overall height: 11.8 (.463) / 12.2 (.480)
- Internal dimensions: 8.9 (.350) / 9.6 (.378)
- Internal dimensions: 0.75 (.030) / 0.85 (.033)
- Internal dimensions: 12.6 (.496) / 12.8 (.504)
- Internal dimensions: 1.95 (.077) / 2.14 (.084)
- Internal dimensions: 25.2 (0.992) / 25.4 (1.000)

End View Dimensions:

- Internal dimensions: 1.95 (.077) / 2.14 (.084)

Component Identification:

- Part Number: APT2X101S20J
- Configuration: Parallel
- Terminals: Cathode 1, Anode 1, Cathode 2, Anode 2

Dimensions in Millimeters and (Inches)

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